February 2000

FDG311N N-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance. These devices are well suited for portable electronics applications.

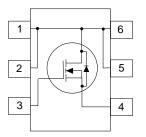
Applications

- Load switch
- Power management
- DC/DC converter

Features

- 1.9 A, 20 V. $R_{DS(ON)} = 0.115 \ \Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 0.150 \ \Omega \ @ V_{GS} = 2.5 \ V.$
- Low gate charge (3nC typical).
- High performance trench technology for extremely low $R_{DS(ON)}$.
- Compact industry standard SC70-6 surface mount package.





Absolute Maximum Ratings T_A = 25 C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			20	V	
V _{GSS}	Gate-Source Voltage			±8	V	
ID	Drain Current	- Continuous	(Note 1a)	1.9	А	
		- Pulsed		6		
PD	Power Dissipation for Single Operation		(Note 1a)	0.75	W	
			(Note 1b)	0.48		
	Operating and Storage Junction Temperature Range					
T _J , T _{stg}			ure Range	-55 to +150	°C	
	al Character			-55 to +150 260	°C/W	
Therma R _{eJA}	Al Character	istics	(Note 1b)			
Therma R _{aJA} Packag	Al Character	istics ance, Junction-to-Ambient	(Note 1b)			

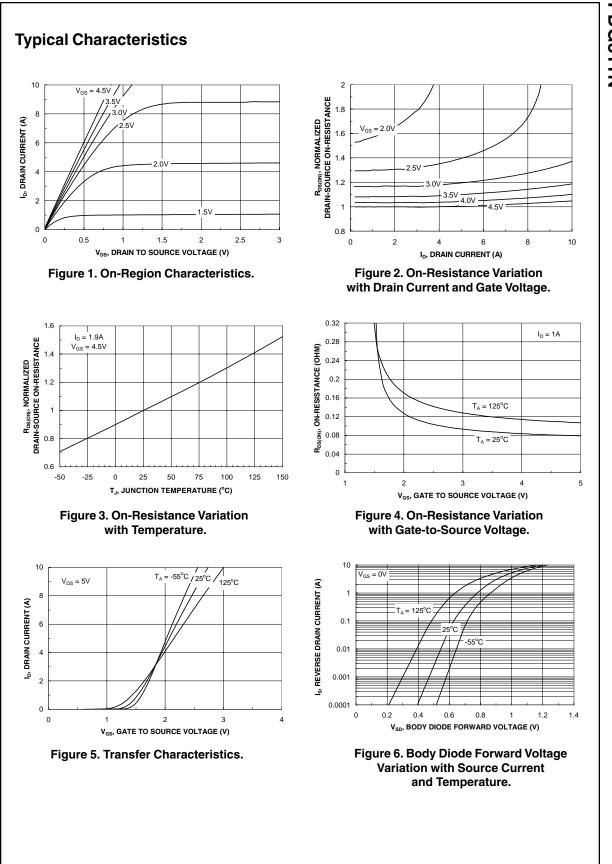
©2000 Fairchild Semiconductor Corporation

Cteristics Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current	V_{GS} = 0 V, I_D = 250 µA I_D = 250 µA, Referenced to 25°C	20			V
Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient		20			V
Coefficient	I_D = 250 µA, Referenced to 25°C				I V
Zero Gate Voltage Drain Current			14		mV/°C
Jano Tonago Diani Ganoni	$V_{DS} = 16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
Gate-Body Leakage Forward	$V_{GS} = 8 V, V_{DS} = 0 V$			100	nA
Gate-Body Leakage Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
cteristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4	0.9	1.5	V
Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV/°0
Static Drain-Source On-Resistance	$V_{GS} = 4.5 V, I_D = 1.9 A$ $V_{GS} = 4.5 V, I_D = 1.9 A,$ $T_J = 125^{\circ}C$ $V_{CS} = 2.5 V, I_D = 1.6 A$		0.082 0.110 0.105	0.115 0.170 0.150	Ω
On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	4			A
Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		6		S
Characteristics					
Input Capacitance	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		270		pF
Output Capacitance	f = 1.0 MHz		55		pF
Reverse Transfer Capacitance	-		20		pF
Characteristics (Note 2)					
Turn-On Delay Time $V_{DD} = 10 \text{ V}, \text{ I}_D = 1 \text{ A},$			5	12	ns
Turn-On Rise Time	$V_{GS} = 5 V, R_{GEN} = 6 \Omega$		9	17	ns
Turn-Off Delay Time	1		10	18	ns
Turn-Off Fall Time	1		2	6	ns
Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.9 \text{ A},$		3	4.5	nC
Gate-Source Charge	$V_{GS} = 4.5 V$		0.6		nC
Gate-Drain Charge			0.9		nC
rce Diode Characteristics	and Maximum Ratings				
				0.42	A
Drain-Source Diode Forward	$V_{GS} = 0 V, I_S = 0.42 A$ (Note 2)		0.7	1.2	V
	Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain-Source On-Resistance On-State Drain Current Forward Transconductance Characteristics Input Capacitance Output Capacitance Characteristics (Note 2) Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Tree Diode Characteristics a Maximum Continuous Drain-Source Drain-Source Diode Forward	teristics (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ AGate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25° CTemperature Coefficient $I_D = 250 \ \mu$ A, Referenced to 25° CStatic Drain-Source $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ COn-Resistance $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ COn-State Drain Current $V_{GS} = 4.5 \ V$, $V_{DS} = 5 \ V$ Forward Transconductance $V_{DS} = 5 \ V$, $I_D = 0.5 \ A$ Characteristics nput Capacitance $V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$, f = 1.0 MHzCharacteristics (Note 2) $V_{DD} = 10 \ V$, $I_D = 1 \ A$, $V_{GS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$ Turn-On Delay Time $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$ Turn-Off Fall Time $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ Total Gate Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ Gate-Source Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ Sate-Drain Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ Maximum Continuous Drain-Source Diode Forward CurrentDrain-Source Diode Forward $V_{GS} = 0 \ V$, $I_S = 0.42 \ A$ (Note 2)	teristics (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ A0.4Gate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25° C0.4Gate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25° C0.4Static Drain-Source $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ C $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ COn-Resistance $V_{GS} = 4.5 \ V$, $I_D = 1.6 \ A$ 0.4On-State Drain Current $V_{GS} = 4.5 \ V$, $V_{DS} = 5 \ V$ 4Forward Transconductance $V_{DS} = 5 \ V$, $I_D = 0.5 \ A$ 0.4CharacteristicsNupset 5 \ V, $I_D = 0.5 \ A$ 0.4Characteristics(Note 2)1.0 \ MHz0.4Turn-On Delay Time $V_{DS} = 10 \ V$, $I_D = 1 \ A$, $V_{GS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$ 0.4Turn-Off Fall Time $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.4Total Gate Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.4Gate-Drain Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.4Total Gate Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.4Gate-Drain Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.4Total Gate Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.4Gate-Drain Charge $V_{DS} = 0.42 \ A$ (Note 2)0.4Total Colse Characteristics and Maximum Ratings0.4.5 \ V_{DS} = 0.42 \ A (Note 2)0.4.5 \ V_{DS} = 0.42 \ ATotal Source Diode Forward </td <td>theristics (Note 2)Gate Threshold Voltage$V_{DS} = V_{GS}$, $I_D = 250 \ \mu$A0.40.9Gate Threshold Voltage$I_D = 250 \ \mu$A, Referenced to 25°C-3Temperature Coefficient$I_D = 250 \ \mu$A, Referenced to 25°C-3Static Drain-Source$V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, <math>T_J = 125°C0.082On-Resistance$V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, <math>T_J = 125°C0.110Dn-State Drain Current$V_{GS} = 4.5 \ V$, $V_{DS} = 5 \ V$4Forward Transconductance$V_{DS} = 5 \ V$, $I_D = 0.5 \ A$6Characteristicsnput Capacitance$V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$, $f = 1.0 \ MHz$270Dutput Capacitance$V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$, $f = 1.0 \ MHz$55Reverse Transfer Capacitance$V_{DD} = 10 \ V$, $I_D = 1 \ A$, $V_{GS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$9Turn-On Delay Time$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$9Turn-Off Fall Time220Total Gate Charge$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$3Gate-Drain Charge$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$0.6Gate-Drain Charge$0.9$0.9rcc Diode Characteristics and Maximum Ratings0.9Maximum Continuous Drain-Source Diode Forward Current0.9</br></math></br></math></br></td> <td>teristics (Note 2)Gate Threshold Voltage$V_{DS} = V_{GS}$, $I_D = 250 \ \mu$A, Referenced to 25°C-3Gate Threshold Voltage$I_D = 250 \ \mu$A, Referenced to 25°C-3Temperature Coefficient$V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$C0.0820.115On-Resistance$V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$C0.1050.150On-State Drain Current$V_{GS} = 4.5 \ V$, $V_{DS} = 5 \ V$4-Forward Transconductance$V_{DS} = 5 \ V$, $I_D = 0.5 \ A$6Characteristics$V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$, $f = 1.0 \ MHz$270Characteristics (Note 2)$V_{DD} = 10 \ V$, $I_D = 1.4 \ A$270Turn-On Delay Time$V_{DS} = 10 \ V$, $I_D = 1.4 \ A$9Turn-On Belay Time$V_{DS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$9Turn-Off Belay Time$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$3Turn-Off Fall Time$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$3Gate-Drain Charge$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$3Gate-Drain Charge$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$0.6Total Gate Charge$V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$0.6Gate-Drain Charge$V_{OS} = 0 \ V$, $I_S = 0.42 \ A$0.42Drain-Source Diode Forward$V_{CS} = 0 \ V$, $I_S = 0.42 \ A$0.7Turn-Off Delay Time$V_{OS} = 0 \ V$, $I_S = 0.42 \ A$0.7</td>	theristics (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ A0.40.9Gate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25°C-3Temperature Coefficient $I_D = 250 \ \mu$ A, Referenced to 25°C-3Static Drain-Source $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, 	teristics (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ A, Referenced to 25° C-3Gate Threshold Voltage $I_D = 250 \ \mu$ A, Referenced to 25° C-3Temperature Coefficient $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ C0.0820.115On-Resistance $V_{GS} = 4.5 \ V$, $I_D = 1.9 \ A$, $T_J = 125^{\circ}$ C0.1050.150On-State Drain Current $V_{GS} = 4.5 \ V$, $V_{DS} = 5 \ V$ 4-Forward Transconductance $V_{DS} = 5 \ V$, $I_D = 0.5 \ A$ 6Characteristics $V_{DS} = 10 \ V$, $V_{GS} = 0 \ V$, $f = 1.0 \ MHz$ 270Characteristics (Note 2) $V_{DD} = 10 \ V$, $I_D = 1.4 \ A$ 270Turn-On Delay Time $V_{DS} = 10 \ V$, $I_D = 1.4 \ A$ 9Turn-On Belay Time $V_{DS} = 5 \ V$, $R_{GEN} = 6 \ \Omega$ 9Turn-Off Belay Time $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 3Turn-Off Fall Time $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 3Gate-Drain Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 3Gate-Drain Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.6Total Gate Charge $V_{DS} = 10 \ V$, $I_D = 1.9 \ A$, $V_{GS} = 4.5 \ V$ 0.6Gate-Drain Charge $V_{OS} = 0 \ V$, $I_S = 0.42 \ A$ 0.42Drain-Source Diode Forward $V_{CS} = 0 \ V$, $I_S = 0.42 \ A$ 0.7Turn-Off Delay Time $V_{OS} = 0 \ V$, $I_S = 0.42 \ A$ 0.7

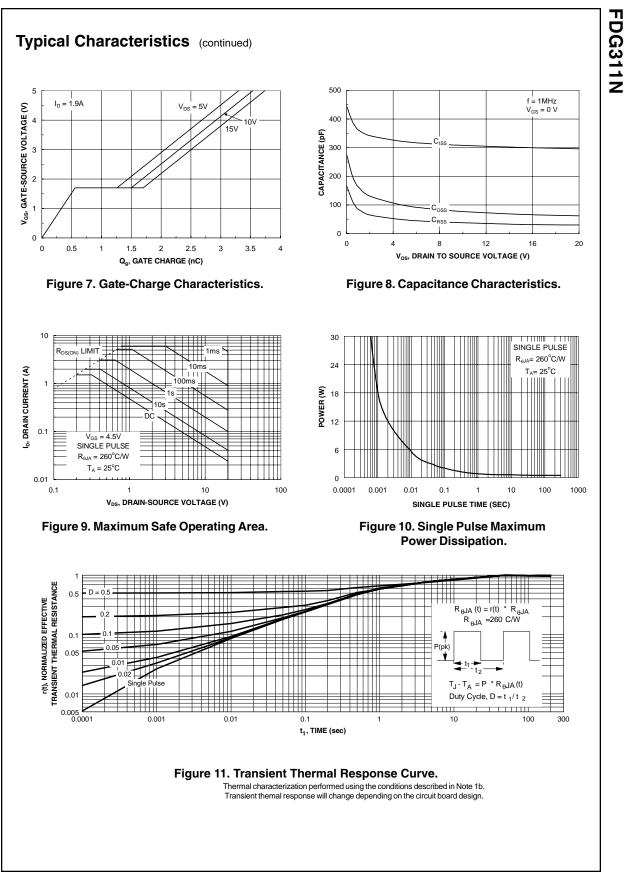
2. Pulse Test: Pulse Width $\leq\!300\,\mu\text{s},$ Duty Cycle $\leq\!2.0\%$

FDG311N Rev. D

FDG311N



FDG311N



FAIRCHILD

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[®] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8

SyncFET™ TinyLogic™ UHC™ VCX™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

www.fairchildsemi.com